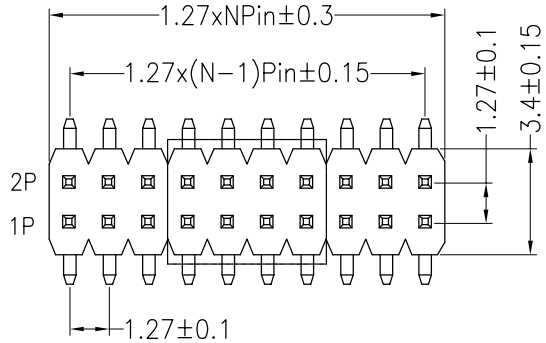
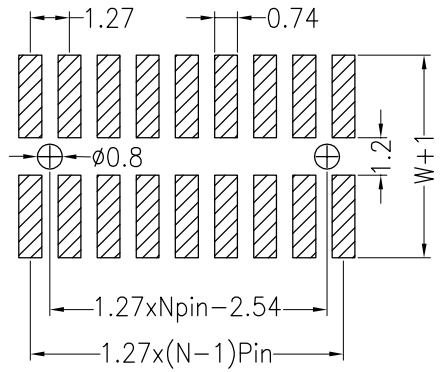
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



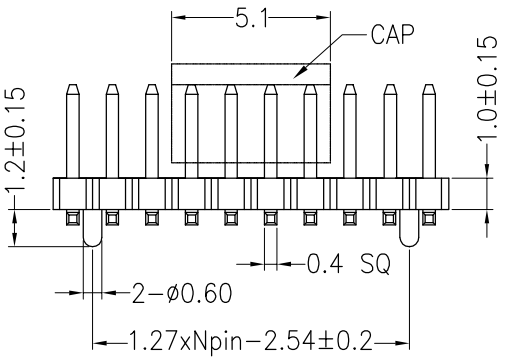
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

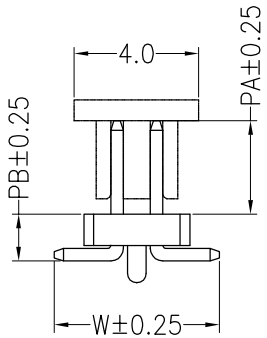


Ordering Information

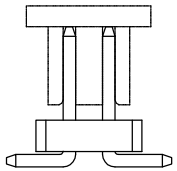
1410 12 XX X X XX M XXX X 0X

No.of Pins Per Row	Insulator Material Option	Post	Contact Plating	Pin Length	Packing	code stream
02~50P	C=BK−PA6T E=BK−PA9T F=BK−LCP	W=with Post N=w/o post	G1:Gold Flash G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold G6:10U" Gold G7:15U" Gold S0:Gold Flash/Tin SN:Tin		0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap M=Reel+Mylar	01~99





W= With Post



N= W/O Post

Dimension antitheses list			
ITEM	PA	PB	W
Standard	3.00	1.50	5.50

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A1	2016.04.22	塑胶件改良,侧面增加槽口	
A0	2012.04.19	NEW DRAWING	

OPERATION		DRAW	Liu Miao	16.04.22
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	141012XXXXXXMXXXX0X
TITLE:	1.27PH 2xnPin H1.0 SMT